

Challenges and prospects for upgrades of the CMS electromagnetic calorimeter front-end readout electronics for HL-LHC

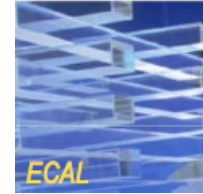
Alexander Singovski, University of Minnesota

On behalf of the CMS Collaboration

NDIP2014, Tours, 30Jun-4Jul 2014



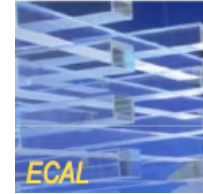
Outlook



- ▶ Legacy ECAL on-detector electronics
- ▶ Motivation for upgrade
- ▶ Possible design of the Phase2 on-detector electronics
- ▶ Challenges and plans



CMS detector. Electromagnetic CALorimeter (ECAL)



- ▶ The largest homogeneous crystal calorimeter ever built
- ▶ Designed to provide high electromagnetic calorimeter performance in the hadron collider environment:
 - ▶ High interaction rate
 - ▶ Hadron background
 - ▶ Pileup
- ▶ To meet this goal, the following solutions were implemented:
 - ▶ Lead tungstate scintillating crystals as a sensitive medium
 - ▶ High granularity:
 - ▶ Barrel: 61200 crystals arranged in 36 SuperModules for pseudo-rapidity range $|\eta| < 1.48$
 - ▶ Two endcaps: each 7324 crystals arranged in four Dees for $|\eta| = 1.48 - 3.00$
 - ▶ High quality digitizer:
 - ▶ 40MeV – 1.5TeV dynamic range (14 bit)
 - ▶ 12 bit precision

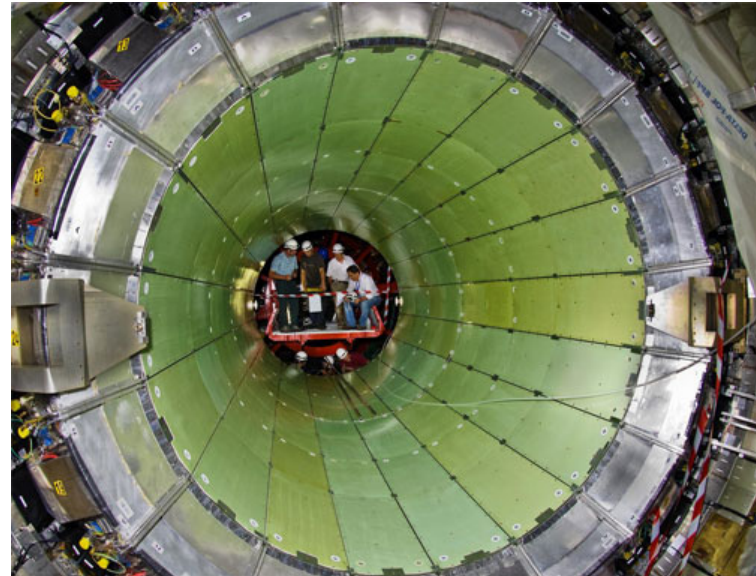
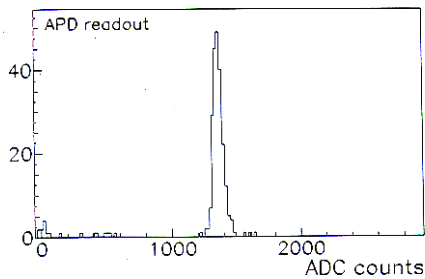
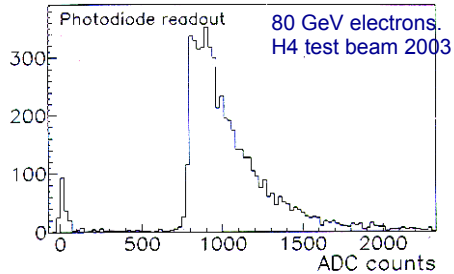
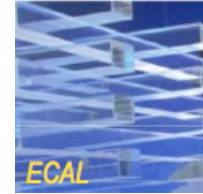
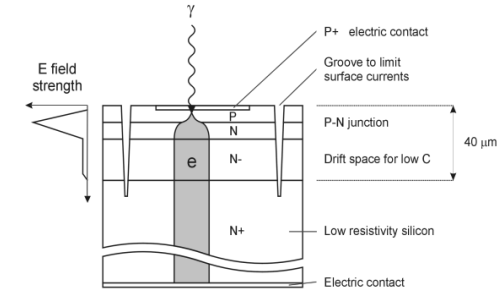




Photo detectors. ECAL Barrel: APD

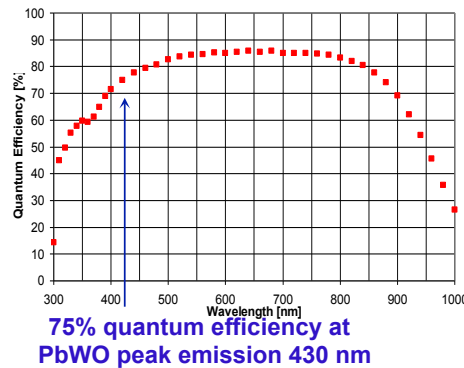
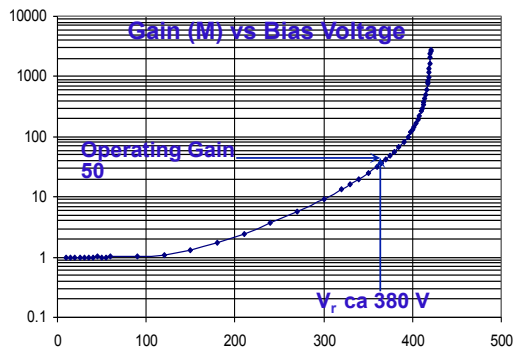
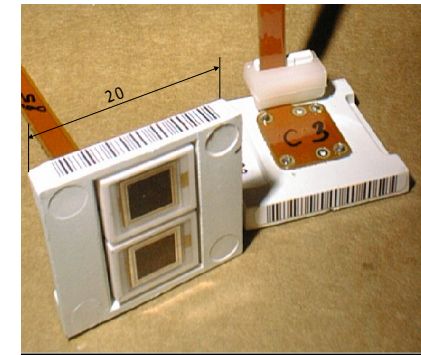


- ▶ Due to the nuclear counting effect, device with the internal gain was required
- ▶ After 8 years R&D of Hamamatsu Photonics in close collaboration with CMS ECAL groups, a new large area Avalanche Photo diode was developed



HAMAMATSU Photonics S8148 APD parameters:

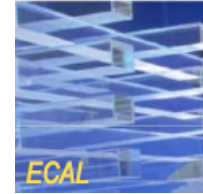
Active area	5 x 5 mm
Charge collection within 20 nsec	99 ± 1%
Capacitance	80 pF (fully depleted)
Serial resistance	< 5 Ω
Dark Current (I _d) before irradiation	< 50 nA (~ 5 nA typical)
Voltage sensitivity (1/M*dM/dV)	3.15 % / V
Temperature sensitivity (1/T*dM/dT) -	2.2 % / °C
Excess noise factor	2.1
Breakdown - operating voltage (V _b - V _r)	45 ± 5 V



Excellent device
 ~150 000 devices purchased by CMS
 All fit to specification
 No problems associated to APD failure after 5 years of operation



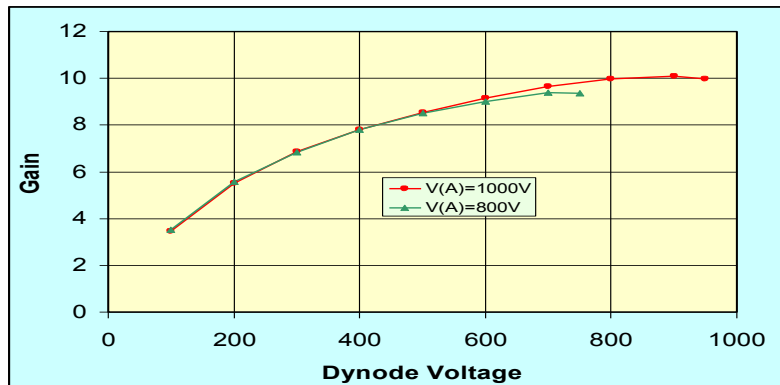
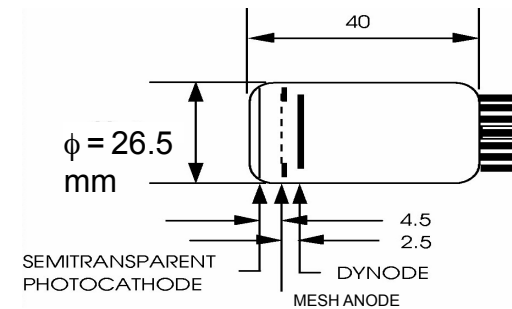
Photo detectors. ECAL EndCap: VPT



Due to the high radiation in the forward region, vacuum photo triode is used in the End Cap section of CMS ECAL

Endcaps: Vacuum phototriodes (VPT)

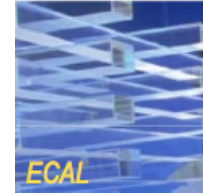
- Produced by RIE, St Petersburg, Russia
- More radiation resistant than Si diodes (with UV glass window)
- Active area $\sim 280 \text{ mm}^2$
- Gain ~ 10 ($B=4T$) Q.E. $\sim 20\%$ (420 nm)
- Fast devices (simple planar structure)



Very good performance. No known problems with VPT so far.



Legacy ECAL Barrel FE electronics system

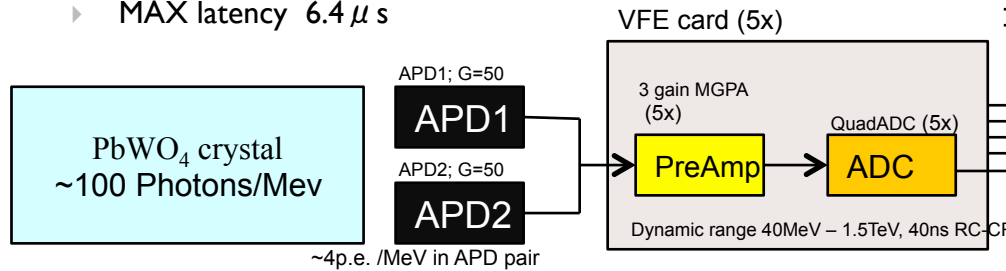
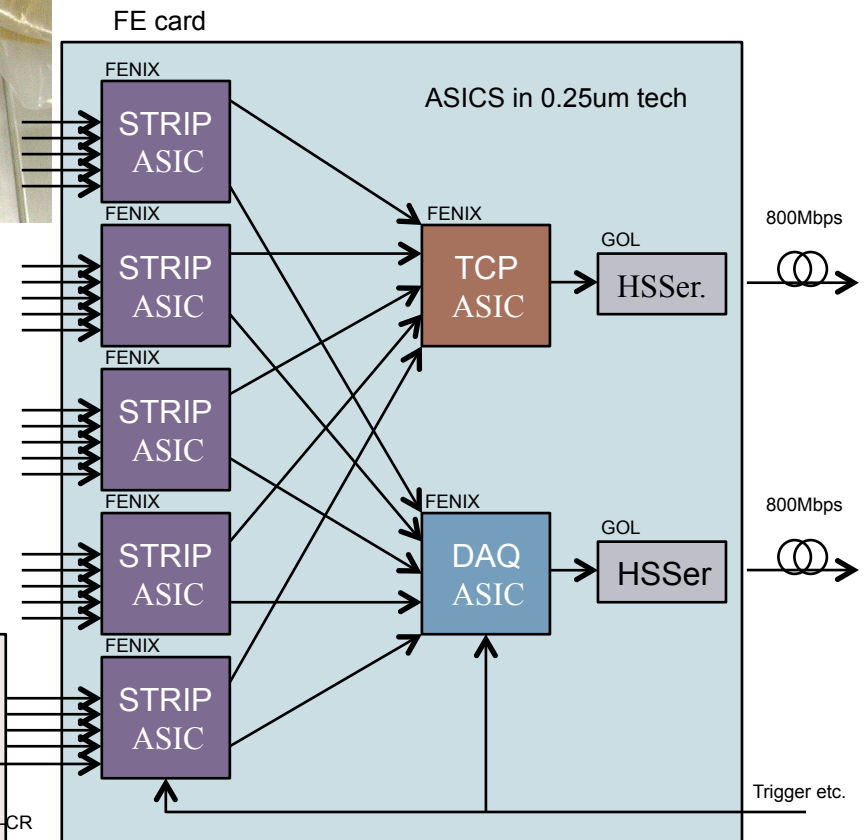
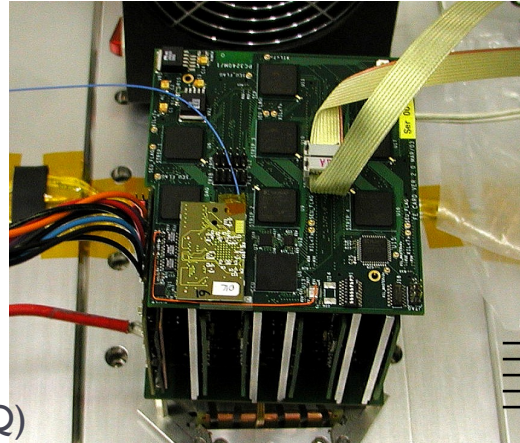


▶ Modularity

- ▶ 25 channels = 1 trigger tower

▶ Features

- ▶ Trigger Primitive generation (FENIX STRIP)
- ▶ Pipeline, event buffer in FE (FENIX TCP and FENIX DAQ)
- ▶ Two readout streams:
 - ▶ For LI trigger 2448 channels @ 40MHz
 $\Delta \eta \Delta \phi = 0087 \times 0.087$
 - ▶ For LI selected event: 61200 channels @ **100KHz**; (max rate ~150kHz)
 $\Delta \eta \Delta \phi = 00147 \times 0.0147$
 - ▶ MAX latency 6.4 μ s





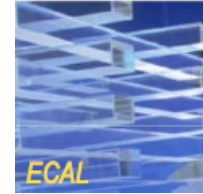
ECAL in hadron collider environment



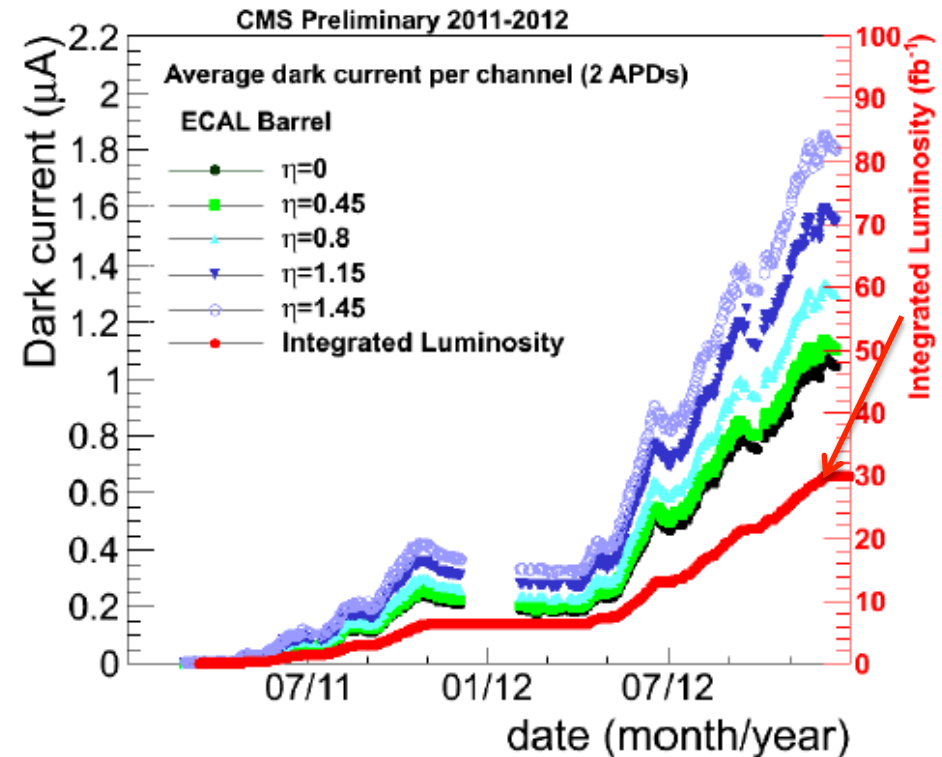
- ▶ **Known problems, taken into account by design:**
 - ▶ Degradation of the signal due to the crystals transmission radiation damage
 - ▶ Increase of the APD dark current due to the neutron irradiation
- ▶ **New problem, discovered after the start of operation**
 - ▶ Anomalous signals from energy deposition directly in the bulk of the APD
 - ▶ Mimic the physical signals, have relatively high rate, much be rejected at trigger level
- ▶ **Foreseen:**
 - ▶ Wide dynamic ADC range, possibility to tune APD gain
 - ▶ High precision light monitoring system
 - ▶ On-line calibration with physical events
 - ▶ Low-noise design of preamplifiers
 - ▶ Big margin in the HV supply current
 - ▶ Possible operation at lower temperature
- ▶ **Trigger-level suppression: use of the hardware diagnostics bits to tag the suspicious events**
- ▶ **Offline: special algorithms to tag and suppress anomalous signals**



APD dark current



- ▶ Noise due to dark current in bulk from irradiation damage (proportional to square root of integrated luminosity)
- ▶ Noise contribution due to dark current increase from ~ 10 MeV at the start of operation to ~ 100 MeV at the end of LHC operation and can reach 400 MeV for HL_LHC \rightarrow become a dominant factor in ECAL energy resolution
- ▶ Option to cool the ECAL from 18C to 8C, should reduce dark current by factor 2 (noise by factor $\sqrt{2}$)
- ▶ Shortening the signal shaping time will also mitigate noise (shorter integration time means less noise)



For more details: poster of [Francesca Addesa](#) "Performance prospects for the CMS electromagnetic calorimeter barrel APDs for LHC runs 2 and 3: radiation hardness and longevity". Poster session Rouge.



Anomalous signals (“spikes”)



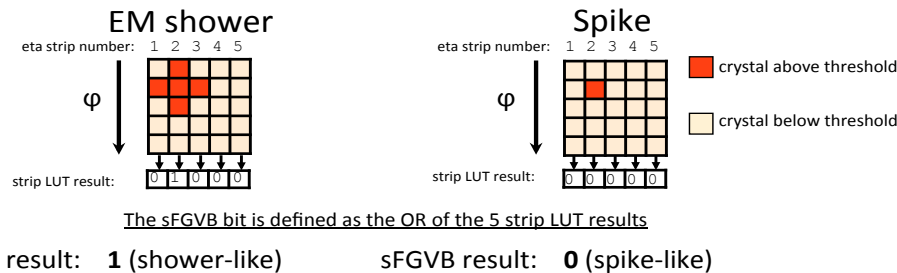
- ▶ Energy deposited directly in the bulk of APD produce a signal
 - ▶ Equivalent to multi-GeV photon shower
 - ▶ Faster than e.m. shower signal
 - ▶ Isolated channel
 - ▶ Rate proportional to instantaneous luminosity

Trigger-level spikes suppression: sFGVB algorithm

Spike-like energy deposits are prevented from triggering CMS by exploiting additional functionality of the ECAL front-end electronics - the **Strip Fine-grained Veto Bit (sFGVB)**.

This bit flags spike-like energy deposits by comparing the E_T recorded for each channel (in a 5x5 crystal region) to a configurable threshold.

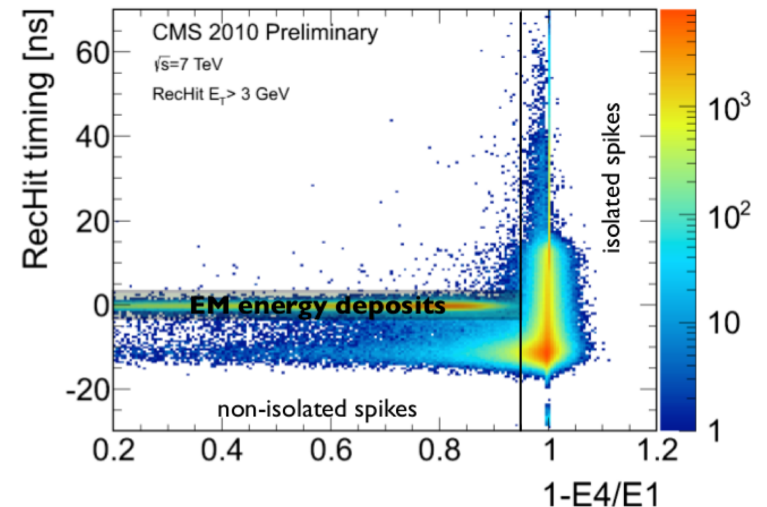
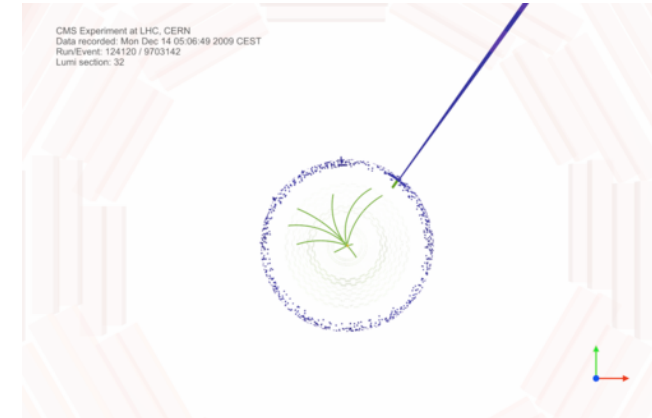
An EM shower should have more than 1 crystal above threshold. A spike will typically contain only one high energy crystal. A look-up table is used to flag strips of 5 channels that contain >1 hit above threshold



A tower is prevented from triggering CMS if the sFGVB is spike-like and the tower transverse energy is greater than a configurable threshold

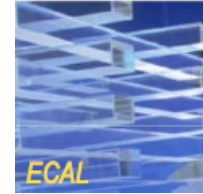
1 The sFGVB has been measured to reject >95% of spikes with transverse energy greater than 8 GeV, with a small (<1%) effect on the efficiency for triggering real electrons with $p_T > 20$ GeV

D.Petit. Upgrade week DESY, June 2013





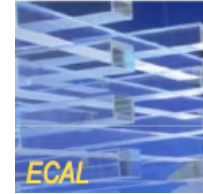
Legacy ECAL FE electronics system, Summary



- ▶ Current ECAL FE electronics fits to the CMS design goals
- ▶ Very good performance
- ▶ Design features (including hidden ones) allow mitigation of the hostile environment – related problems



From LHC to HL_LHC



- ▶ Integrated luminosity
 - ▶ LHC: 300fb^{-1} by 2023 → HL-LHC: 3000fb^{-1} by 2035
- ▶ Instantaneous luminosity
 - ▶ LHC: $1 \times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$ → HL-LHC: $5 \times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$

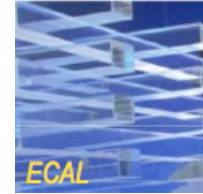


- ▶ Pileup
 - ▶ LHC: 30 → HL-LHC: 140
- ▶ Crystal transmission radiation damage (loss of signal)
 - ▶ HL-LHC: x5 LHC e.m. damage (saturates, ~ to the instantaneous luminosity)
 - ▶ HL-LHC : x10 hadron damage (~ to integrated luminosity)
- ▶ APD dark current
 - ▶ HL-LHC: x10 LHC (~ to integrated luminosity)

ECAL Barrel detector: PbWO_4 crystals and APDs will continue to work well in HL-LHC conditions. No replacement required.



HL-LHC: ECAL on-detector electronics requirements



▶ Requirements

▶ Trigger rate up to 1 MHz

- ▶ Legacy max ~150 kHz

▶ Trigger latency up to ~20 us

- ▶ Legacy max ~6 us

- ▶ Full installation during LHC Long Shutdown 3 (2023-2025)

- ▶ Maintained or improved reliability and availability

- ▶ Improve the EB spike mitigation

▶ High on the wish list

- ▶ ADC encoding: optimisation for new conditions, noise level, pile-up, spike rejection

- ▶ Decrease the Low Voltage Current delivered to the Front End system in order to decrease the physical volume required for services

- ▶ Robust failure mitigation scheme

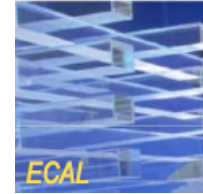
Legacy ECAL on-detector electronics is incompatible with HL-LHC **trigger** system due to:

- Trigger rate
- Extended latency driven by tracker trigger

→ **Replacement required**



New on-detector electronics design



Legacy system:

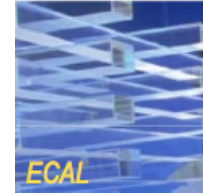
- ▶ Digitizer at LHC clock, 40MHz
- ▶ Trigger Tower (5x5 crystals) – based readout
- ▶ Trigger primitives generated by FENIX chips on FE board are sent to LI trigger at 40MHz
- ▶ Readout at 100KHz MAX due to the limited optical data link speed, 0.8Gbps
 - ▶ LI trigger for readout
 - ▶ On-board buffer → limited latency

Upgraded system:

- ▶ Digitizer at LHC clock, 40MHz
 - ▶ Possibility to increase digitization rate to mitigate pileup and noise problems
- ▶ Read ALL data from each crystal
 - ▶ 16bit x 25 crystals x 40MHz → 16Gbps per Trigger Tower
 - ▶ NO on-line trigger
 - ▶ NO latency limit
- ▶ Maximum use of the industrial products
- ▶ Common R&D for LHC experiments
 - ▶ Rad. Hard serializer: GBT Project
 - P. Moreira et. Al **The GBT-SerDes ASIC prototype**, TOPICAL WORKSHOP ON ELECTRONICS FOR PARTICLE PHYSICS 2010, AACHEN, GERMANY
 - ▶ Rad. Hard optical transmitter/receiver: Versatile Link project
 - J. Troska et. Al. **Versatile transceiver and transmitter production status**, TOPICAL WORKSHOP ON ELECTRONICS FOR PARTICLE PHYSICS 2013, PERUGIA, ITALY
 - ▶ Rad. Hard low voltage regulator
 - S. Michelis et. Al. , **Custom DC-DC converters for distributing power in SLHC trackers**, Topical Workshop on Electronics for Particle Physics, 2008, Naxos, Greece



HL-LHC, ECAL barrel FE electronics Design idea



▶ Modularity

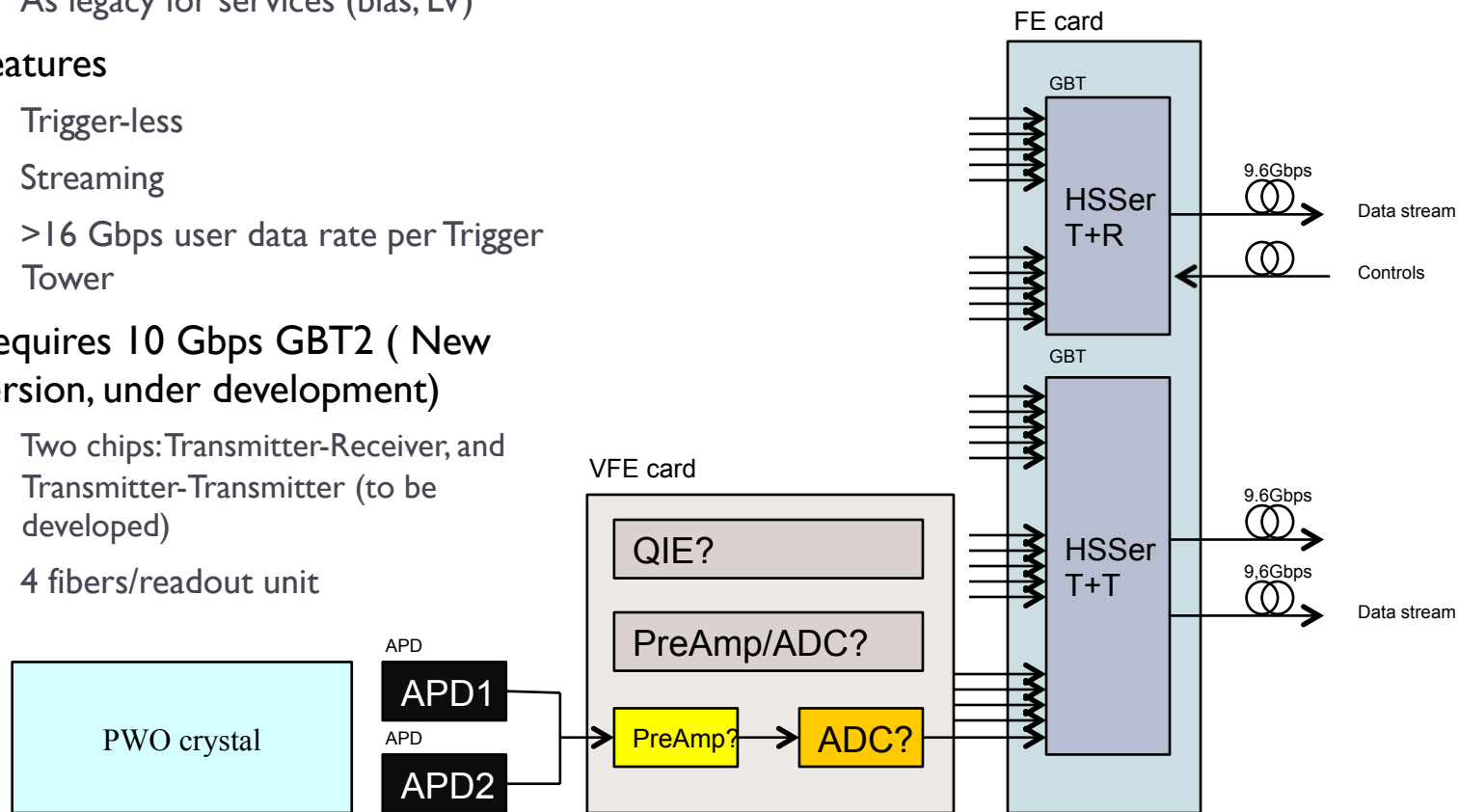
- ▶ 1 channel for readout and trigger.
Trigger Tower mechanical modularity.
- ▶ As legacy for services (bias, LV)

▶ Features

- ▶ Trigger-less
- ▶ Streaming
- ▶ >16 Gbps user data rate per Trigger Tower

▶ Requires 10 Gbps GBT2 (New version, under development)

- ▶ Two chips: Transmitter-Receiver, and Transmitter-Transmitter (to be developed)
- ▶ 4 fibers/readout unit





HL-LHC, ECAL barrel FE electronics

Design idea, backup option



▶ Modularity

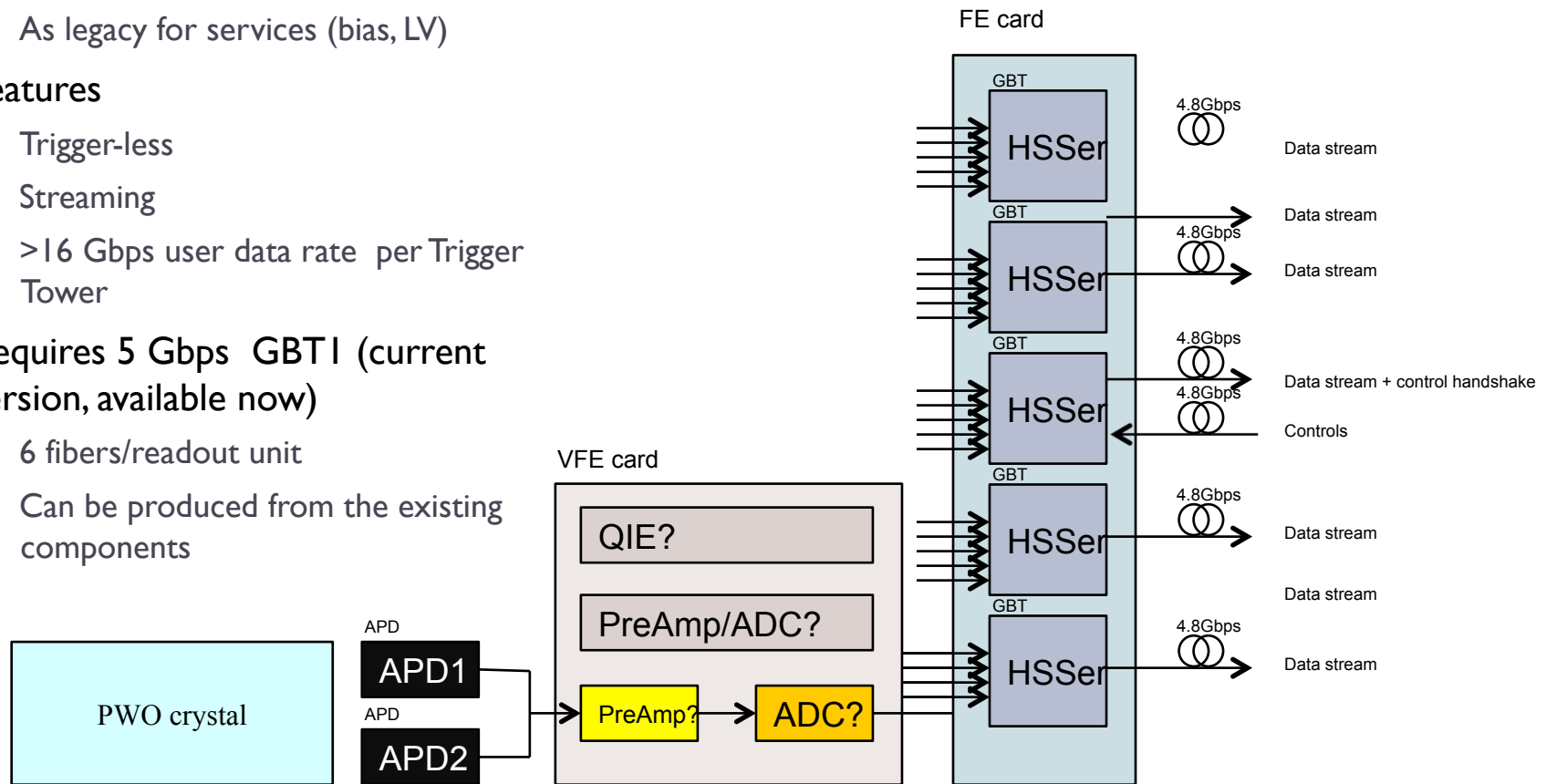
- ▶ 1 channel for readout and trigger.
Trigger Tower mechanical modularity.
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▶ Features

- ▶ Trigger-less
- ▶ Streaming
- ▶ >16 Gbps user data rate per Trigger Tower

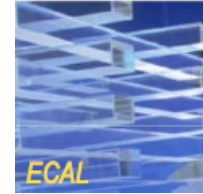
▶ Requires 5 Gbps GBT1 (current version, available now)

- ▶ 6 fibers/readout unit
- ▶ Can be produced from the existing components



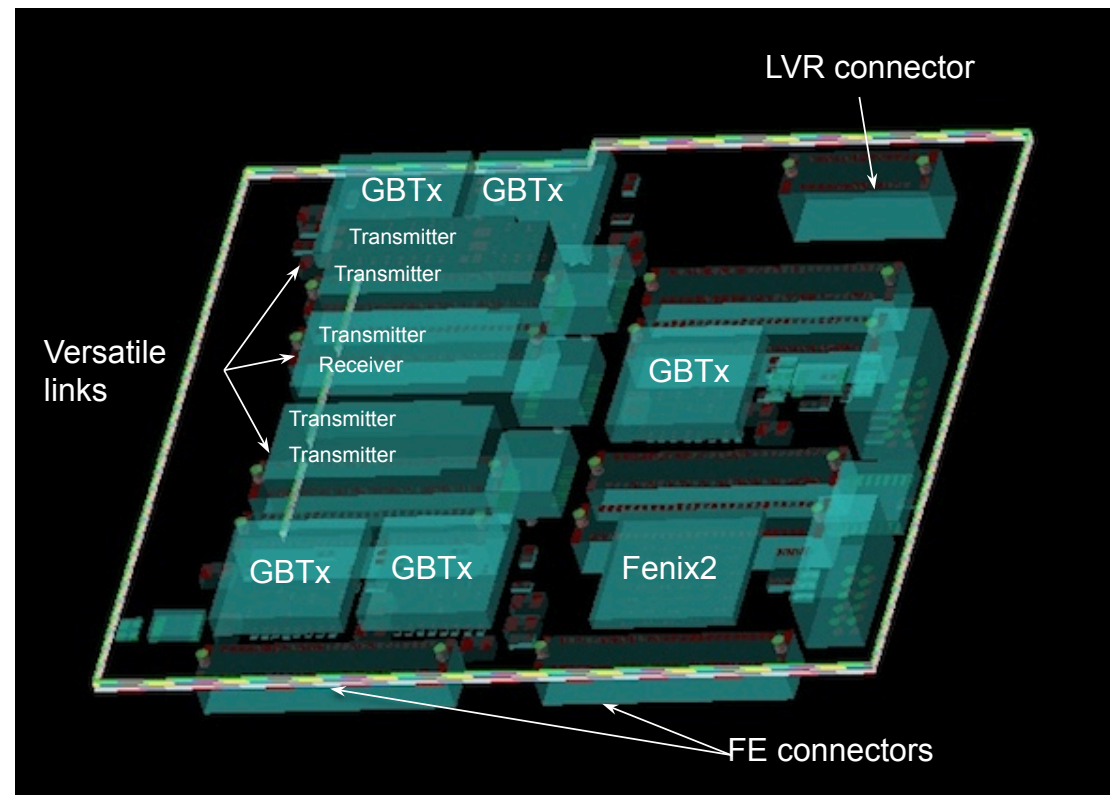


Upgraded FE card, conservative design



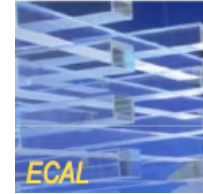
Sketch of the possible Upgrade FE implementation with the existing components

- ▶ Demonstrator board
- ▶ Can replace legacy FE board
- ▶ Fit to HL-LHC specs
- ▶ Can be produced mostly from the existing components
 - ▶ New FENIX2 chip should be developed

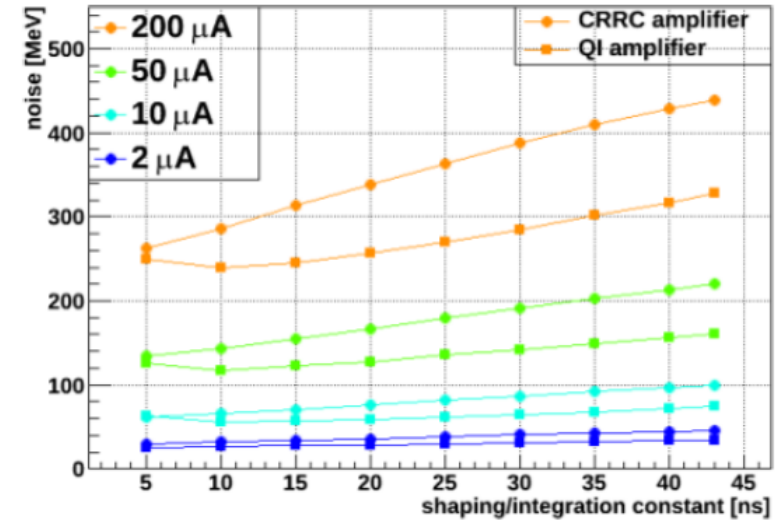




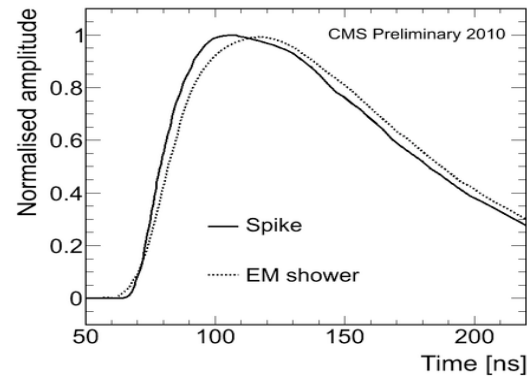
Upgrade of preamplifier and shaping



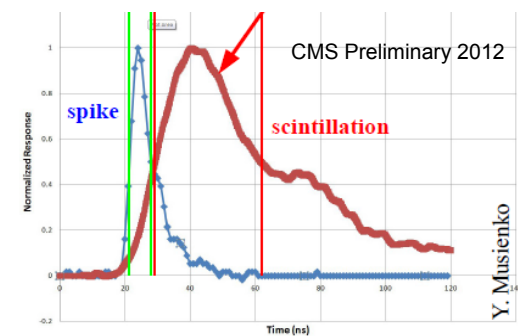
- ▶ Possible re-optimization of the pre-amplifier
 - ▶ Higher clock frequency: 80MHz, ... : shorter shaping time to integrate less noise and less pile-up
 - ▶ Alternative approach
 - ▶ Integrate charge on one clock (25ns): a'la QIE chip, developed for CMS HCAL (Fermilab)
 - ▶ Complement with a precise time measurement
 - ▶ Spikes rejection by timing



CMS data: after preamp. and 40MHz digitizer.

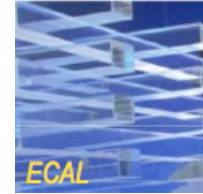


Test beam data: APD output, measured with 2GHz oscilloscope

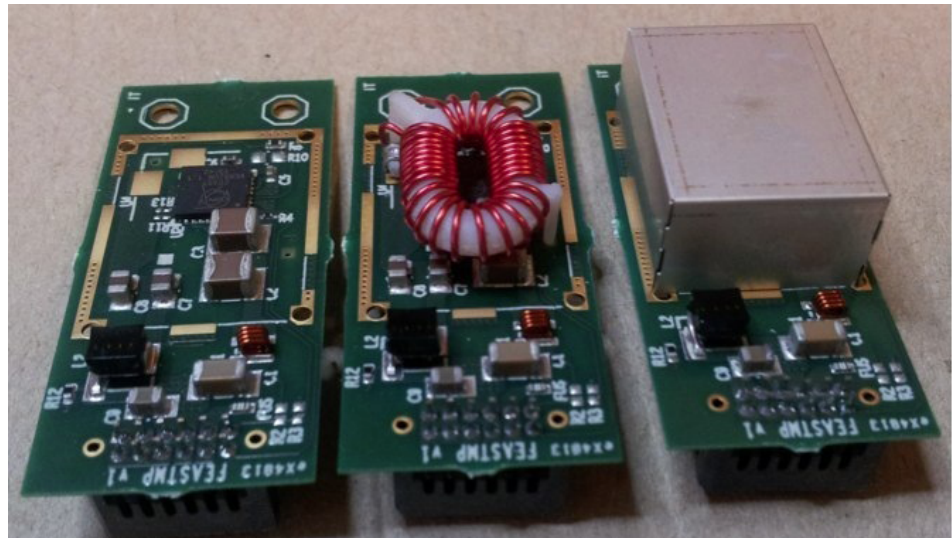




Low Voltage Regulators card



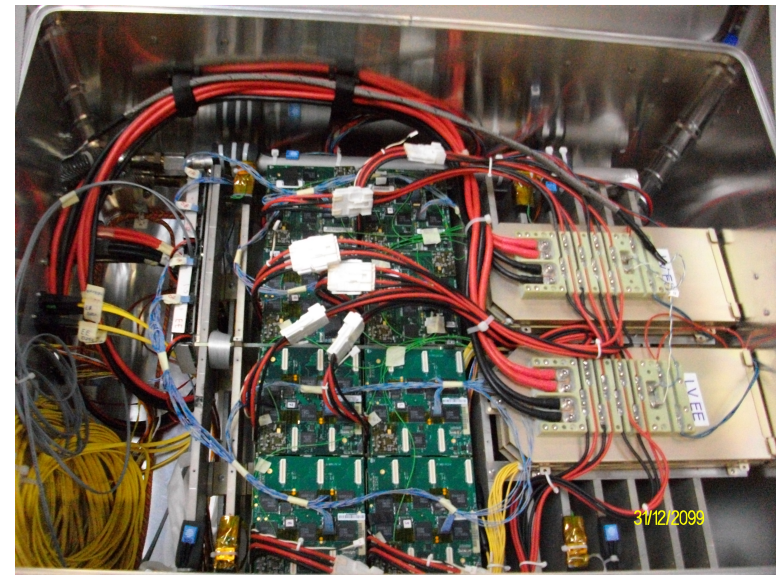
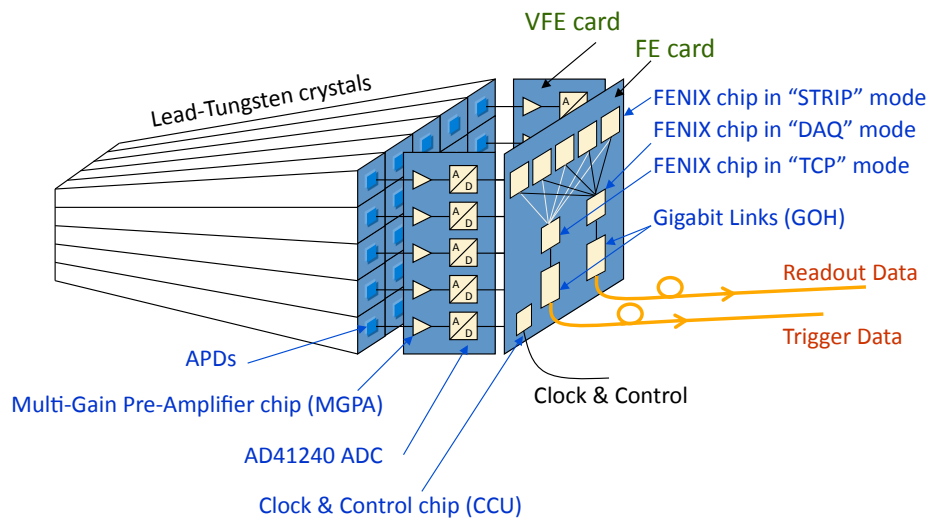
- ▶ Service card, depend on VFE and FE design
 - ▶ Possibly will supply several voltages
- ▶ CERN R&D project for new rad. hard and magnetic field tolerant DC-DC converter
 - Recent status described in ACES2014 by Federico Faccio, CERN.
<https://indico.cern.ch/event/287628/session/1/contribution/14/material/slides/0.pdf>
 - ▶ Step-down conversion: 12V \rightarrow 2.5V
 - ▶ Higher efficiency
 - ▶ ~2 times less current to deliver
 - ▶ Current design is optimized for ATLAS tracker. The form-factor is not suitable for ECAL. Customization is required





Longevity Study

- ▶ Some of the EB on-detector electronic components will be re-used in the upgraded version
 - ▶ APD + kapton cables
 - ▶ **Motherboards (MB)**
- ▶ Accelerated aging test of MB, VFE, FE, LVR and TRLB to 40 years (climatic chamber)
- ▶ No failures seen after 16 years equivalent ageing



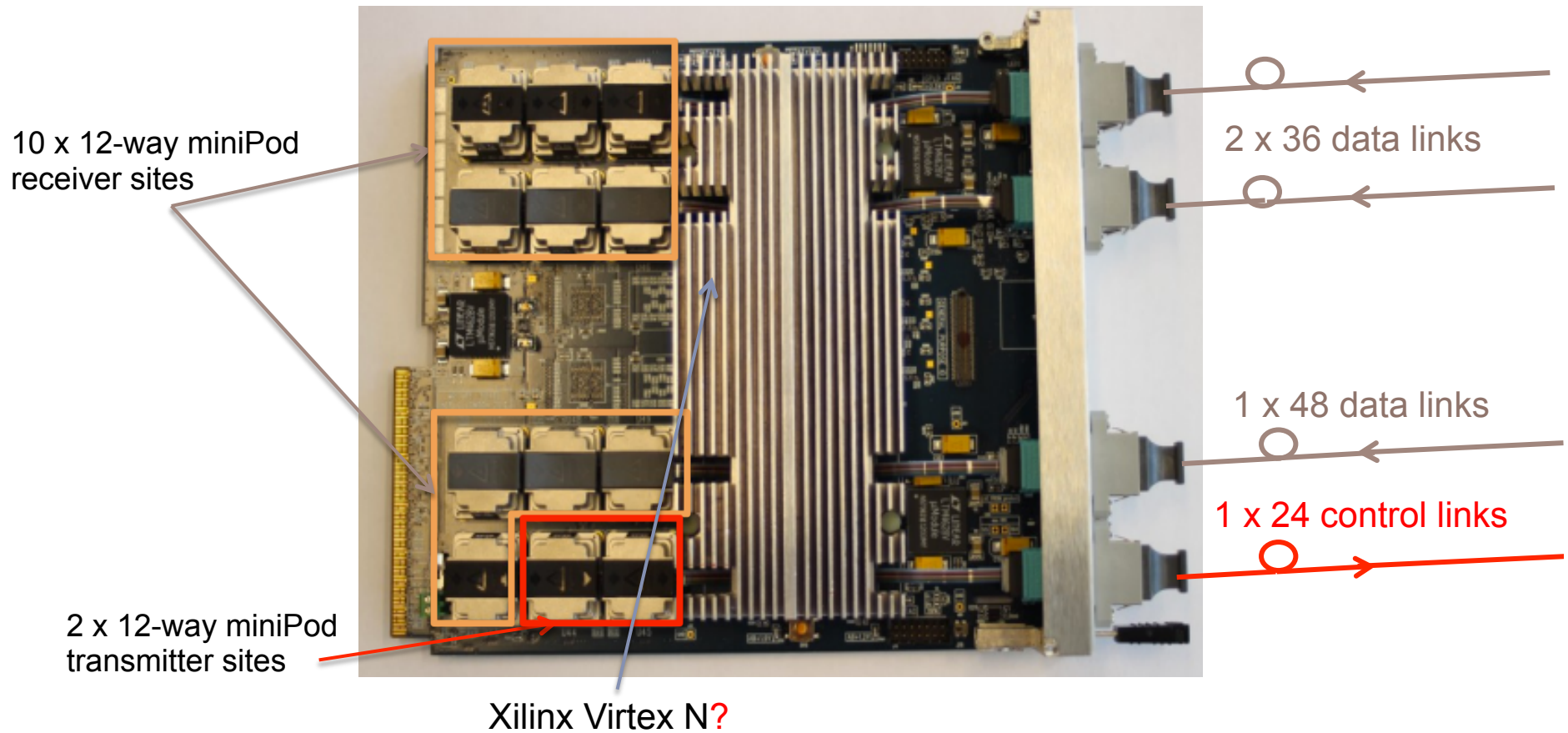
Front End Tester in Bat. 904



Off-detector electronics

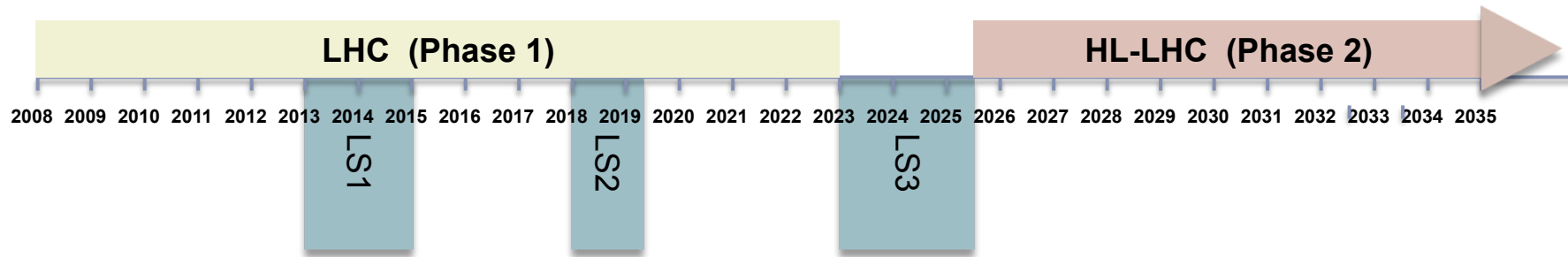


Option for Off-detector Control/Readout: Build new MP7' more suited to ECAL FE requirements





Schedule



VFE

- Design
- Prototyping
- Production

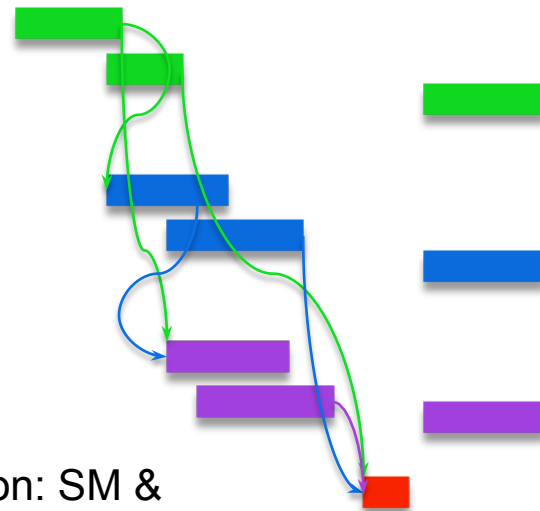
FE

- Design
- Prototyping
- Production

LVR

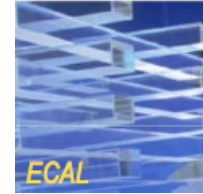
- Design
- Prototyping
- Production

Beam Test validation: SM & New FE electronics





On-detector electronics upgrade logistics



- ▶ EB electronics upgrade will require extraction-installation-commissioning of 36 SuperModules
 - ▶ Required time – 18 months





Summary



- ▶ HL-LHC ECAL on-detector electronics upgrade is required by the trigger
- ▶ PbWO_4 crystals, APDs, Mother Boards, and 5x5 Trigger Tower structure will **not** be replaced
- ▶ Minimal upgrade would be replacement of the Front-End card
 - ▶ Can be implemented with the already existing components
 - ▶ Will benefit from the on-going CERN GBT2 and Versatile link-2 R&D projects
- ▶ Very-Front-End card can be optimized to better mitigate pileup and anomalous events in APD. R&D is on-going
- ▶ Low Voltage Regulator card will be upgraded to supply new VFE and FE cards
- ▶ Laser monitoring will be upgraded for better performance in HL-LHC environment
- ▶ Crystal ECAL EndCap will not survive in the HL-LHC environment , hence should be replaced. Two options are under study. One of which, Shashlyk calorimeter, can also use the upgraded EB VFE-FE electronics